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#### CDCDB2000

ZHCSKG8A-NOVEMBER 2019-REVISED FEBRUARY 2020

# 符合 CDCDB2000 DB2000QL 标准的 20 输出时钟缓冲器,适用于 PCIe 第 1 代到第 5 代

# 1 特性

- 具有集成 85Ω 输出终端的 20 LP-HCSL 输出
- 8 硬件输出使能端 (OE#) 控制装置
- 使用 DB2000QL 滤波器之后的附加相位抖动: < 0.08ps rms
- 支持 PCle 第 4 代和第 5 代常见时钟 (CC) 频率和 单独基准 (IR) 架构
  - 与扩频兼容
- 周期到周期抖动: < 50ps
- 输出到输出偏斜: < 50ps
- 输入到输出延迟: < 3ns
- 3.3V 内核和 IO 电源电压
- 硬件控制的低功耗模式 (PD#)
- 用于在 PD# 模式下进行输出控制的边带接口 (SBI)
- 9 个可选 SMBus 地址
- 功耗: < 600mW
- 6mm × 6mm, 80 引脚 TLGA/GQFN 封装

# 2 应用

- 微服务器和塔式服务器
- 存储区域网络和主机总线适配器卡
- 网络附加存储
- 硬件加速器

# 3 说明

CDCDB2000 是一款符合 DB2000QL 标准的 20 输出 LP-HCSL 时钟缓冲器,能够为 PCIe 第 1 代到第 5 代、QuickPath Interconnect (QPI)、UPI、SAS 和 SATA 接口分配参考时钟。使用 SMBus、SBI 和 8 输 出使能引脚,可以单独配置和控制所有 20 个输出。 CDCDB2000 是一个 DB2000QL 衍生缓冲器,达到或 超过 DB2000QL 规格中的系统参数。CDCDB2000 采 用具有 80 个引线的 6mm × 6mm TLGA/GQFN 封 装。

器件信息<sup>(1)</sup>

器件型号	封装	封装尺寸(标称值)
CDCDB2000	TLGA (80)	6.00mm × 6.00mm

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附 录。

### CDCDB2000 系统图



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# 4 修订历史记录

注: 之前版本的页码可能与当前版本有所不同。

Changes from Original (November 2019) to Revision A	
Changes from Original (November 2015) to Nevision A	

• C	hanged maximum	input voltage from:VDD+	0.3 V to: VDD+ 0.5 V	/	7
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# 5 Pin Configuration and Functions



**Pin Functions** 

PIN			DESCRIPTION		
NAME	NO.	WO TIPE	DESCRIPTION		
INPUT CLOCK					
CLKIN_P	G1	I	LP-HCSL differential clock input. Typically connected directly to the differential		
CLKIN_N	H1	I	output of clock source.		
OUTPUT CLOCKS					
CK0_P	J1	0	LP-HCSL differential clock output of channel 0. Typically connected directly to		
CK0_N	K1	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK1_P	L1	0	LP-HCSL differential clock output of channel 1. Typically connected directly to		
CK1_N	M1	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK2_P	M2	0	LP-HCSL differential clock output of channel 2. Typically connected directly to		
CK2_N	M3	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK3_P	M4	0	LP-HCSL differential clock output of channel 3. Typically connected directly to		
CK3_N	M5	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK4_P	M7	0	LP-HCSL differential clock output of channel 4. Typically connected directly to PCIe differential clock input. If unused, the pins can be left no connect.		
CK4_N	M8	0			

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# Pin Functions (continued)

PIN			DESCRIPTION		
NAME	NO.	WO TIPE	DESCRIPTION		
CK5_P	M9	0	LP-HCSL differential clock output of channel 5. Typically connected directly to		
CK5_N	M10	0	Cie differential clock input. If unused, the pins can be left no connect, and pin L8 (OE5# / DATA) is recommended to be either in DATA mode or pulled high.		
CK6_P	M11	0	LP-HCSL differential clock output of channel 6. Typically connected directly to		
CK6_N	M12	0	(OE6# / CLK) is recommended to be either in CLK mode or pulled high.		
CK7_P	L12	0	LP-HCSL differential clock output of channel 7. Typically connected directly to		
CK7_N	K12	0	K11 (OE7#) is recommended to be pulled high to disable channel 7 output.		
CK8_P	J12	0	LP-HCSL differential clock output of channel 8. Typically connected directly to		
CK8_N	H12	0	H11 (OE8#) is recommended to be pulled high to disable channel 8 output.		
CK9_P	G12	0	LP-HCSL differential clock output of channel 9. Typically connected directly to		
CK9_N	F12	0	PCIe differential clock input. If unused, the pins can be left no connect, and pin E12 (OE9#) is recommended to be pulled high to disable channel 9 output.		
CK10_P	D12	0	LP-HCSL differential clock output of channel 10. Typically connected directly to		
CK10_N	C12	0	E11 (OE10# / SHFT_LD#) is recommended to be either in SHFT_LD# mode or pulled high.		
CK11_P	B12	0	LP-HCSL differential clock output of channel 11. Typically connected directly to		
CK11_N	A12	0	PCIe differential clock input. If unused, the pins can be left no connect, and pin C11 (OE11#) is recommended to be pulled high to disable channel 11 output.		
CK12_P	A11	0	LP-HCSL differential clock output of channel 12. Typically connected directly to		
CK12_N	A10	0	PCIe differential clock input. If unused, the pins can be left no connect, and pin B10 (OE12#) is recommended to be pulled high to disable channel 12 output.		
CK13_P	A9	0	LP-HCSL differential clock output of channel 13. Typically connected directly to		
CK13_N	A8	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK14_P	A7	0	LP-HCSL differential clock output of channel 14. Typically connected directly to		
CK14_N	A6	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK15_P	A5	0	LP-HCSL differential clock output of channel 15. Typically connected directly to		
CK15_N	A4	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK16_P	A3	0	LP-HCSL differential clock output of channel 16. Typically connected directly to		
CK16_N	A2	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK17_P	A1	0	LP-HCSL differential clock output of channel 17. Typically connected directly to		
CK17_N	B1	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK18_P	C1	0	LP-HCSL differential clock output of channel 18. Typically connected directly to		
CK18_N	D1	0	PCIe differential clock input. If unused, the pins can be left no connect.		
CK19_P	E1	0	LP-HCSL differential clock output of channel 19. Typically connected directly to		
CK19_N	F1	0	PCIe differential clock input. If unused, the pins can be left no connect.		
MANAGEMENT AN	D CONTROL	[			
			Clock Power Good and Power Down multi-function input pin with internal $120 \text{-}k\Omega$ pulldown. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect.		
CKPWRGD_PD#	M6	I, PD	up device. After PWRGD has been asserted high for the first time, the pin becomes a PD# pin and it controls power-down mode: LOW: Power-down mode, all output channels tri-stated. HIGH: Normal operation mode.		
OE5#			Output enable for channel 5 and Side-Band Interface data multi-function pin with internal 120-k $\Omega$ pulldown. Typically connected to GPIO of microcontroller. If both modes are unused, the pin can be left no connect.		
DATA	L8	I, PD	When pin E2 = LOW, OE5# mode. Output enable for channel 5, active low. LOW: enable output channel 5. HIGH: disable output channel 5.		
			when pin $z = \pi \Theta \pi$ , DATA mode. Side-Band Interface data pin.		



# Pin Functions (continued)

PIN			DESCRIPTION		
NAME	NO.	NOTTPE	DESCRIPTION		
056#			Output enable for channel 6 and Side-Band Interface clock multi-function pin with internal 120-k $\Omega$ pulldown. Typically connected to GPIO of microcontroller. If both modes are unused, the pin can be left no connect.		
CLK	L10	I, PD	When pin E2 = LOW, OE6# mode. Output Enable for channel 6, active low. LOW: enable output channel 6. HIGH: disable output channel 6.		
			When pin E2 = HIGH, CLK mode. Side-Band interface clock pin.		
OE7#	K11	I, PD	Output Enable for channel 7 with internal 120-kΩ pulldown, active low. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. LOW: enable output channel 7. HIGH: disable output channel 7.		
OE8#	H11	I, PD	Output Enable for channel 8, with internal $120$ -k $\Omega$ pulldown, active low. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. LOW: enable output channel 8. HIGH: disable output channel 8.		
OE9#	E12	I, PD	Output Enable for channel 9, with internal $120$ -k $\Omega$ pulldown, active low. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. LOW: enable output channel 9. HIGH: disable output channel 9.		
			Output enable for channel 10 and Side-Band Interface load shift registers multi- function pin with internal 120-k $\Omega$ pulldown. Typically connected to GPIO of microcontroller. If both modes are unused, the pin can be left no connect.		
OE10#	E11	I, PD	When pin E2 = LOW, OE10# mode. Output Enable for channel 10, active low. LOW: enable output channel 10. HIGH: disable output channel 10.		
			When pin E2 = HIGH, SHFT_LD# mode. Side-Band Interface load shift registers pin. LOW: disable Side-Band Interface shift register. HIGH: enable Side-Band Interface shift register. A falling edge transfers the Side-Band shift register contents to the output register.		
OE11#	C11	I, PD	Output Enable for channel 11 with internal $120 \text{-}k\Omega$ pulldown, active low. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. LOW: enable output channel 11. HIGH: disable output channel 11.		
OE12#	B10	I, PD	Output Enable for channel 12 with internal 120-k $\Omega$ pulldown, active low. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. LOW: enable output channel 12. HIGH: disable output channel 12.		
SBEN	E2	I, S, PD	Side-Band Interface enable input with internal 120-k $\Omega$ pulldown. Typically connected to GPIO of microcontroller. If unused, the pin can be left no connect. This pin disables the Output Enable (OE#) pins when asserted. LOW: OE# pins and SMBus enable bits control outputs, Side-Band interface disabled. HIGH: Side-Band Interface controls outputs, OE# pins and SMBus enable bits are disabled.		
SMBUS AND SMBU	JS ADDRESS				
			SMBus address strap bit[0]. This is a 3-level input that is decoded in conjunction with pin B8 to set SMBus address. It has internal $120-k\Omega$ pullup / pulldown network biasing to VDD/2 when no connect.		
SADR0	B4	I, S, PU / PD	through an external pullup resistor from 1k to 5k with 5% tolerance. For a low-level input configuration input, the pin should be pulled down to ground through an external pulldown resistor from 1k to 5k with 5% tolerance.		
			For a mid-level input configuration, the pin should be left floating and not connected to VDD or ground.		



#### Pin Functions (continued)

PIN			DESCRIPTION		
NAME	NO.	I/O I TPE	DESCRIPTION		
SADR1	B8	I, S, PU / PD	SMBus address strap bit[1]. This is a 3-level input that is decoded in conjunction with pin B4 to set SMBus address. It has internal 120-k $\Omega$ pullup / pulldown network biasing to VDD/2 when no connect. For a high-level input configuration, the pin should be pulled up to 3.3-V VDD through an external pullup resistor from 1k to 5k with 5% tolerance. For a low-level input configuration, the pin should be pulled down to ground through an external pulldown resistor from 1k to 5k with 5% tolerance. For a mid-level input configuration, the pin should be pulled down to ground through an external pulldown resistor from 1k to 5k with 5% tolerance. For a mid-level input configuration, the pin should be left floating and not connected to VDD or ground.		
SMBCLK	L5	I	Clock pin of SMBus interface. Typically pulled up to 3.3-V VDD using external pullup resistor. The recommended pullup resistor value is > 8.5k.		
SMBDAT	L4	I/O	Data pin of SMBus interface. Typically pulled up to 3.3-V VDD using external pullup resistor. The recommended pullup resistor value is > 8.5k.		
SUPPLY VOLTAGE	AND GROUND				
GND	DAP	G	Ground. Connect ground pad to system ground.		
VDD	B2, B6, B11, L2, L11	Р	Power supply input for LP-HCSL clock output channels. Connect to 3.3-V power supply rail with decoupling capacitor to GND. Place a $0.1-\mu$ F capacitor close to each supply pin between power supply and ground.		
VDD_A	H2	Р	Power supply input for differential input clock. Connect to 3.3-V power supply rail with decoupling capacitor to GND. Place a $0.1$ - $\mu$ F capacitor close to pin.		
NO CONNECT					
NC	B3, B5, B7, B9, C2, D2, D11, F2, F11, G2, G11, J2, J11, K2, L3, L6, L7, L9,	_	Do not connect to GND or VDD.		

The "#" symbol at the end of a pin name indicates that the active state occurs when the signal is at a low voltage level. When "#" is not present, the signal is active high.

The definitions below define the I/O type for each pin.

- I = Input
- O = Output
- I / O = Input / Output
- PU / PD = Internal 120-k $\Omega$  Pullup / Pulldown network biasing to VDD/2
- PD = Internal 120-kΩ Pulldown
- S = Hardware Configuration Pin
- P = Power Supply
- G = Ground



# 6 Specifications

### 6.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
V <sub>DD,</sub> V <sub>DD_A</sub>	Power supply voltage	-0.3	3.6	V
V <sub>IN</sub>	IO input voltage	GND	V <sub>DD</sub> + 0.5	V
TJ	Junction temperature		125	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# 6.2 ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatio discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>		V
	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	±1000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V <sub>DD</sub>	IO supply voltage	3.135	3.3	3.465	V
V <sub>DD_A</sub>	Core supply voltage	3.135	3.3	3.465	V
T <sub>A</sub>	Ambient temperature	-40		85	°C
TJ	Junction temperature			125	°C

#### 6.4 Thermal Information

		CDCDB2000	
	THERMAL METRIC <sup>(1)</sup>	NPP (GQFN)	UNIT
		80 PINS	
$R_{\thetaJA}$	Junction-to-ambient thermal resistance	32.7	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	31.2	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	15.9	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	0.4	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	15.8	°C/W
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	1.5	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

# 6.5 Electrical Characteristics

VDD, VDD\_A = 3.3 V  $\pm$  5 %, -40 °C < TA < 85 °C. Typical values are at VDD = VDD\_A = 3.3 V, 25 °C (unless otherwise noted)

PARAMETER TEST CONDITIONS		MIN	TYP	MAX	UNIT	
CURRENT	CONSUMPTION					
		Active mode. CKPWRGD_PD# = 1		12		~ ^
IDD_A	Core supply current	Power down mode. CKPWRGD_PD# = 0	8		ma	

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#### **Electrical Characteristics (continued)**

VDD, VDD\_A = 3.3 V ± 5 %, -40 °C < TA < 85 °C. Typical values are at VDD = VDD\_A = 3.3 V, 25 °C (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
		All-outputs disabled			20		
I <sub>DD</sub>	IO supply current per output	All-outputs active, 100MHz			200		mA
		Power down mode. CKPWRG	D_PD# = 0		8		
CLOCK IN	PUT						
f <sub>IN</sub>	Input frequency			50	100	250	MHz
V <sub>IN</sub>	Input voltage swing	Differential voltage between C CLKIN_N <sup>(1)</sup>	LKIN_P and	200		2300	mV <sub>Diff-</sub> <sub>peak</sub>
dV/dt	Input voltage edge rate	20% - 80% of input swing		0.7			V/ns
DV <sub>CROSS</sub>	Total variation of V <sub>CROSS</sub>	Total variation across V <sub>CROSS</sub>			140		mV
DCIN	Input duty cycle			40		60	%
C <sub>IN</sub>	Input capacitance <sup>(2)</sup>	Differential capacitance betwe and CLKIN_N pins	en CLKIN_P		2.2		pF
CLOCK OL	JTPUT						
f <sub>OUT</sub>	Output frequency			50	100	250	MHz
C <sub>OUT</sub>	Output capacitance <sup>(1)</sup>	Differential capacitance betwe and CKx_N pins	en CKx_P		2.2		pF
V <sub>OH</sub>	Output high voltage	(2)		225		270	
V <sub>OL</sub>	Output low voltage	Single-ended (2)(0)		10		150	
V <sub>CROSS</sub>	Crossing point voltage	Input V <sub>CROSS</sub> varied by 140 m	V. <sup>(3)(4)</sup>	130		200	
DV <sub>CROSS</sub>	Total variation of V <sub>CROSS</sub>	Input V <sub>CROSS</sub> varied by 140 mV. Variation of V <sub>CROSS</sub> <sup>(3)(4)</sup>				35	mV
Vovs	Overshoot voltage	(3)				V <sub>OH</sub> +75	
V <sub>uds</sub>	Undershoot voltage	(3)				V <sub>OL</sub> -75	
Z <sub>DIFF</sub>	Differential impedance	Measured at V <sub>OL</sub> /V <sub>OH</sub>		81	85	89	
Z <sub>DIFF_CROS</sub>	Differential impedance	Measured at V <sub>CROSS</sub>		68	85	102	ohm
t <sub>EDGE</sub>	Edge rate	Measured at V <sub>CROSS</sub>		2		20	V/ns
Dt <sub>EDGE</sub>	Edge rate matching	Measured at V <sub>CROSS</sub>				20	%
t <sub>STABLE</sub>	Power good assertion to stable clock output	CKPWRGD_PD# pin transistions from 0 to 1, f <sub>IN</sub> = 100 MHz	Measured when PWRGD reaches 0.2V			1.8	ms
t <sub>DRIVE_PD#</sub>	Power good assertion to outputs driven high	CKPWRGD_PD# pin transistions from 0 to 1, f <sub>IN</sub> = 100 MHz	Measured when PWRGD reaches 0.2V			300	μs
t <sub>OE</sub>	Output enable assertion to stable clock output	OEx# pin transistions from 1 to 0				10	
t <sub>OD</sub>	Output enable de-assertion to no clock output	OEx# pin transistions from 0 to 1				10	CLKIN Periods
t <sub>PD</sub>	Power down assertion to no clock output	CKPWRGD_PD# pin transistic	ons from 1 to			3	
t <sub>DCD</sub>	Duty cycle distortion	Differential; $f_{IN} = 100MHz$ , $f_{in_{II}}$	<sub>DC</sub> = 50%	-1.0		1.0	%
t <sub>DLY</sub>	Propagation delay			<sup>(5)</sup> 0.5		3	ns

Voltage swing includes overshoot.
 Not tested in production. Ensured by design and characterization.

(3) Measured into DC test load.

(4) V<sub>CROSS</sub> is single-ended voltage when CKx\_P = CKx\_N with respect to system ground. Only valid on rising edge of CKx, when CKx\_P is rising.

Measured from rising edge of CLK\_IN to any CKx output. (5)



#### **Electrical Characteristics (continued)**

VDD, VDD\_A = 3.3 V  $\pm$  5 %, -40 °C < TA < 85 °C. Typical values are at VDD = VDD\_A = 3.3 V, 25 °C (unless otherwise noted)

PARAMETER		TEST CONDITION	TEST CONDITIONS		TYP	MAX	UNIT
t <sub>SKEW</sub>	Skew between outputs					<sup>(6)</sup> 50	ps
	Additive jitter	DB2000QL filter				0.08	ps, rms
	Additive jitter for PCIe5	PCIe5.0 filter				0.03	ps, rms
J <sub>CKx_PCIE</sub>	Additive jitter for PCIe4	PLL BW = 2 - 5 MHz; CDR =	Input clock slew rate ≥ 1.8 V/ns			0.08	ps, rms
	Additive jitter for PCIe3	10 MHz	Input clock slew rate ≥ 0.6 V/ns			0.15	ps, rms
J <sub>CKx_PCIE</sub>	Additive jitter for PCIe2	PCIe2 filter				0.2	ps, rms
J <sub>CKx_PCIE</sub>	Additive jitter for PCIe1	PCIe1 filter				5	ps, rms
Ј <sub>СКх</sub>	Additive jitter	$f_{IN} = 100 \text{ MHz}$ ; slew rate $\ge 3 \text{ V/}$ to 20 MHz integration bandwidt	′ns; 12 kHz th.		155		fs, rms
SMBUS IN	TERFACE, SIDE-BAND INTERFACE,	OEx#, CKPWRGD_PD#, SBEN					
V <sub>IH</sub>	High-level input voltage			2.0			V
V <sub>IL</sub>	Low-level input voltage					0.8	v
		With internal pull up/pull-down		-30		30	
IIL	Input leakage current	Without internal pull up/pull- down	< V <sub>DD</sub>	-5		5	uA
C <sub>IN</sub>	Input capacitance				4.5		pF
C <sub>OUT</sub>	Output capacitance				4.5		pF
3-LEVEL D	IGITAL INTERFACE (SA_0, SA_1)		·				
V <sub>IHT</sub>	High-level input voltage			2.4			
V <sub>IMT</sub>	Mid level input voltage			1.3	$V_{DD}/2$	1.8	V
V <sub>ILT</sub>	Low-level input voltage					0.9	
I <sub>INT</sub>	Input high current	$VIN = V_{DD}, VIN = GND$		-10		10	
I <sub>Leak</sub>	Input leakage current	With internal pull up/pull-down	GND < V <sub>IN</sub> < V <sub>DD</sub>	-30		30	uA

(6) Measured from rising edge of any CKx output to any other CKx output.

### 6.6 Timing Requirements

VDD, VDD\_A = 3.3 V  $\pm$  5 %, -40 °C < TA < 85 °C. Typical values are at VDD = VDD\_A = 3.3 V, 25 °C (unless otherwise noted)

		MIN	NOM MAX	UNIT			
SMBUS-COMPATIBLE INTERFACE TIMING							
f <sub>SMB</sub>	SMBus operating frequency	10	100	kHz			
t <sub>BUF</sub>	Bus free time between STOP and START	4.7					
t <sub>HD_STA</sub>	START condition hold time	4		μs			
t <sub>SU_STA</sub>	START condition setup time	4.7					
t <sub>SU_STO</sub>	STOP condition setup time	4					
t <sub>HD_DAT</sub>	SMBDAT hold time	300					
t <sub>SU_DAT</sub>	SMBDAT setup time	250		ns			
t <sub>TIMEOUT</sub>	Detect SMBCLK low timeout	25	35	ms			
t <sub>LOW</sub>	SMBCLK low period	4.7					
t <sub>HIGH</sub>	SMBCLK high period	4	50	μδ			
t <sub>LOW_SL</sub>	Cumulative clock low extend time		25	ms			



### **Timing Requirements (continued)**

VDD, VDD\_A = 3.3 V ± 5 %, -40 °C < TA < 85 °C. Typical values are at VDD = VDD\_A = 3.3 V, 25 °C (unless otherwise noted)

			MIN	NOM	MAX	UNIT
t <sub>F</sub>	SMBCLK/SMBDAT fall time <sup>(1)</sup>				300	
t <sub>R</sub>	SMBCLK/SMBDAT rise time <sup>(2)</sup>				1000	ns
SIDE-BA	ND INTERFACE TIMING					
t <sub>PERIOD</sub>	Clock period		40			
t <sub>SETUP</sub>	Setup time to clock		25			
t <sub>DSU</sub>	Data set up time		10			ns
t <sub>DHOLD</sub>	Data hold time		5			
t <sub>DELAY</sub>	Delay time		25			
t <sub>PDLY</sub>	Propagation delay		4		10	CLK periods
t <sub>SLEW</sub>	Clock slew rate	20% - 80%	0.2		3	V/ns

(1) TF = (VIHMIN + 0.15) to (VILMAX - 0.15) (2) TR = (VILMAX - 0.15) to (VIHMIN + 0.15)



图 1. Start-Up With CLKIN Timing Diagram







图 3. SMBus Timing Diagram





CDCDB2000

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Texas

# 6.7 Typical Characteristics





### 7 Detailed Description

#### 7.1 Overview

The CDCDB2000 is a low additive-jitter, low propagation delay clock buffer designed to meet the strict performance requirements for PCIe Gen 1-5, QPI and UPI reference clocks. The CDCDB2000 allows buffering and replication of a single clock source to up to 20 individual outputs in the LP-HCSL format. The outputs of the CDCDB2000 can be configured before they are enabled using the Side-Band control interface. The CDCDB2000 also includes status and control registers accessible by an SMBus version 2.0 compliant interface. The device integrates a large amount of external passive components to reduce overall system cost.

#### 7.2 Functional Block Diagram



#### 7.3 Feature Description

#### 7.3.1 Output Enable Control

The CDCDB2000 allows two methods to control the state of the output channels: SMBus/OE#, and Side-Band Interface. Only one of the two methods can be active at any time, and the active interface is selected by the state of the SBEN pin. Both methods of output control can assign the state of each output individually.

When in SMBus/OE# control is selected, the OE# pins become active. The OE# pins control the state of the output with the same number. For example, the OE5# pin controls the state of the CK5 output driver. The SMBus registers may enable/disable the output regardless of the OE# pin state if desired.

#### 7.3.2 SMBus

The CDCDB2000 has an SMBus interface that is active only when CKPWRGD\_PD# = 1.The SMBus allows individual enable/disable of each output when the SMBus mode is selected using the SBEN pin.

When CKPWRGD\_PD# = 0, the SMBus pins are placed in a Hi-Z state, but all register settings are retained. The SMBus register values are only retained while VDD\_A remains inside of the recommended operating voltage.

#### Feature Description (接下页)

#### 7.3.2.1 SMBus Address Assignment

The SMBus address is assigned by configuration of two pins (SADR1 and SADR0) that each support three levels. This configuration allows the CDCDB2000 to assume 9 different SMBus addresses.

The SMBus address pins are sampled PWRGD is set to 1. See  $\frac{1}{8}$  1 for address pin configuration. The address cannot be changed until the PWRGD state is cleared by powering down the device.

#### 表 1. SMBus Address Assignment

SADR1	SADR0	SMBUS ADDRESS
L	L	0xD8
L	Μ	0xDA
L	Н	0xDE
Μ	L	0xC2
М	Μ	0xC4
Μ	Н	0xC6
Н	L	0xCA
Н	Μ	0xCC
Н	Н	0xCE

#### 7.3.3 Side-Band Interface

The Side-Band Interface(SBI) is a basic 3-wire interface that consists of the DATA, CLK and SHFT\_LD# pins. The SBI is used to shift data into a 20-bit long shift register. When the SHFT\_LD# pin is high, the rising edge of CLK can shift DATA into the shift register. After shifting data, the falling edge of SHFT\_LD# clocks the shift register contents to the SBI output register.

While SBI is enabled by the SBEN pin, OE[7:9, 11, 12]# pins are disabled and DATA, CLK and SHFT\_LD# are enabled on the OE5#, OE6# and OE10# pins, respectively.

When power has been applied, and SBEN = 1, the SBI is active regardless of the CKPWRGD\_PD# pin state. This characteristic allows loading the shift register and transferring the contents to the SBI output register before the first assertion of the CKPWRGD\_PD# pin.

#### 7.4 Device Functional Modes

#### 7.4.1 CKPWRGD\_PD# Function

The CKPWRGD\_PD# pin is used to set 2 state variables inside of the device: PWRGD, and PD#. The PWRGD and PD# variables control which functions of the device are active at any time, as well as the state of the input and output pins.

The PWRGD and PD# states are multiplexed on the CKPWRGD\_PD# pin. CKPWRGD\_PD# must remain below VOL and not exceed VDD\_A + 0.3 V until VDD, VDD\_A, and CLKIN are present and within the recommended operating conditions.

The first rising edge of the CKPWRGD\_PD# pin sets PWRGD = 1. After PWRGD is set to 1, the CKPWRGD\_PD# pin is used to assert PD# mode only. PWRGD variable will only be cleared to 0 with the removal of VDD and VDD\_A.



### Device Functional Modes (接下页)



#### 图 6. PWRGD and PD# State Changes

#### 7.4.2 OE[12:5]# and SMBus Output Enables

Each output channel, 0 to 19, can be individually enabled or disabled by SMBus control register bits, called SMB enable bits. Additionally, each output channel from 12 to 5 has a dedicated, corresponding, OE[12:5]# hardware pin. The OE[12:5]# pins are asynchronously asserted-low signals that may enable or disable the output.

Refer to  $\frac{1}{8}$  2 for enabling and disabling outputs through the hardware and software. Note that both the SMB enable bit must be a '1' and the OEx# pin must be an input low voltage '0' for the output channel to be active.

 $\frac{1}{8}$  2 is only valid when the SBEN signal is low (SBEN = 0).

INPUTS			OE[12:5]# HARDWARE PINS AND SMBus CONTROL REGISTER BITS			
PWRGD	PD#	CLKIN	SMBus ENABLE BIT (byte[2:0])	OE[12:5]#	CK[12:5]	CK[19:13, 4:0]
0	Х	Х	X	Х	LOW	LOW
1	0	Х	X	Х	Tristate	Tristate
1	1	Running	0	Х	0	0
1	1	Running	1	0	Running	Running
1	1	Running	1	1	0	Running

#### 表 2. OE[12:5]# Functionality When SBEN = 0

#### 7.5 Programming

The CDCDB2000 has two methods to program the states of its 20 output drivers: SMBus and SBI.

To select between SMBus and SBI interfaces, the SBEN pin is used. Pulling the SBEN to a high level enables the SBI. Pulling the SBEN pin to ground enables the SMBus interface. When SBI is enabled, the SMBus Mask registers are active. The SMBus Mask registers allow the function of the SBI shift registers to be disabled and set the each individual channel as enabled. See 🕅 7 for a diagram of how the SMBus Mask registers and SBI shift registers and SBI shift register interact to enable or disable each output.



# Programming (接下页)





#### 7.5.1 SMBus

SMBus programming is described in SMBus, and the registers are described in Register Maps .

#### 7.5.2 SBI

Side-Band Interface (SBI) is a simple 3-wire serial interface. This interface consists of DATA, CLK and SHFT\_LD# pins. When the SHFT\_LD# pin is high, the rising edge of CLK clocks DATA into a shift register. After shifting data, the falling edge of SHFT\_LD# loads the shift register contents into the Output Register. Both the SBI and the traditional SMBus interface feed common output enable/disable synchronization logic, which ensures glitch-free enable and disable outputs regardless of the method used.

SBI can be configured at a system level in three ways: star topology, daisy chain topology, and directly. The star topology is shown in  $\mathbb{E}$  8. The daisy chain topology is shown in  $\mathbb{E}$  9.



图 8. SBI Star Topology



# Programming (接下页)



图 9. SBI Daisy Chain Topology

#### 7.6 Register Maps

#### 7.6.1 CDCDB2000 Registers

Table 3 lists the CDCDB2000 registers. All register locations not listed in Table 3 should be considered as reserved locations and the register contents should not be modified.

Address	Acronym	Register Name	Section
0h	OECR1	Output Enable Control 1	Go
1h	OECR2	Output Enable Control 2	Go
2h	OECR3	Output Enable Control 3	Go
3h	OERDBK	Output Enable Read Back	Go
4h	SBRDBK	SBEN Read Back	Go
5h	VDRREVID	Vendor/Revision Identification	Go
6h	DEVID	Device Identification	Go
7h	BTRDCNT	Byte Read Count Control	Go
8h	SBIMSK1	Side-Band Interface Override Control 1	Go
9h	SBIMSK2	Side-Band Interface Override Control 2	Go
Ah	SBIMSK3	Side-Band Interface Override Control 3	Go

#### Table 3. CDCDB2000 Registers

Complex bit access types are encoded to fit into small table cells. Table 4 shows the codes that are used for access types in this section.

Access Type	Code	Description			
Read Type					
R	R	Read			
Write Type					
W	W	Write			
Reset or Default Value					
-n		Value after reset or the default value			

#### Table 4. CDCDB2000 Access Type Codes

#### 7.6.1.1 OECR1 Register (Address = 0h) [reset = 78h]

OECR1 is shown in Table 5.

Return to the Summary Table.

The OECR1 register contains bits that enable or disable individual output clock channels [19:16]

Table 5.	OECR1	Register	Field	Descriptions
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Bit	Field	Туре	Reset	Description
7	RESERVED	R	0h	Reserved
6	Output Enable, CK19	R/W	1h	This bit controls the output enable signal for output channel CK19_P/CK19_N.
				0h = Output Disabled
				1h = Output Enabled
5	Output Enable, CK18	R/W	1h	This bit controls the output enable signal for output channel CK18_P/CK18_N.
				0h = Output Disabled
				1h = Output Enabled



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Bit	Field	Туре	Reset	Description
4	Output Enable, CK17	R/W	1h	This bit controls the output enable signal for output channel CK17_P/CK17_N.
				0h = Output Disabled
				1h = Output Enabled
3	Output Enable, CK16	R/W	1h	This bit controls the output enable signal for output channel CK16_P/CK16_N.
				0h = Output Disabled
				1h = Output Enabled
2-0	RESERVED	R	0h	Reserved

#### Table 5. OECR1 Register Field Descriptions (continued)

# 7.6.1.2 OECR2 Register (Address = 1h) [reset = FFh]

OECR2 is shown in Table 6.

Return to the Summary Table.

The OECR2 register contains bits that enable or disable individual output clock channels [7:0]

Bit	Field	Туре	Reset	Description
7	Output Enable, CK7	R/W	1h	This bit controls the output enable signal for output channel CK7_P/CK7_N.
				0h = Output Disabled
				1h = Output Enabled
6	Output Enable, CK6	R/W	1h	This bit controls the output enable signal for output channel CK6_P/CK6_N.
				0h = Output Disabled
				1h = Output Enabled
5	Output Enable, CK5	R/W	1h	This bit controls the output enable signal for output channel CK5_P/CK5_N.
				0h = Output Disabled
				1h = Output Enabled
4	Output Enable, CK4	R/W	1h	This bit controls the output enable signal for output channel CK4_P/CK4_N.
				0h = Output Disabled
				1h = Output Enabled
3	Output Enable, CK3	R/W	1h	This bit controls the output enable signal for output channel CK3_P/CK3_N.
				0h = Output Disabled
				1h = Output Enabled
2	Output Enable, CK2	R/W	1h	This bit controls the output enable signal for output channel CK2_P/CK2_N.
				0h = Output Disabled
				1h = Output Enabled
1	Output Enable, CK1	R/W	1h	This bit controls the output enable signal for output channel CK1_P/CK1_N.
				0h = Output Disabled
				1h = Output Enabled
0	Output Enable, CK0	R/W	1h	This bit controls the output enable signal for output channel CK0_P/CK0_N.
				0h = Output Disabled
				1h = Output Enabled

#### Table 6. OECR2 Register Field Descriptions

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### 7.6.1.3 OECR3 Register (Address = 2h) [reset = FFh]

OECR3 is shown in Table 7.

Return to the Summary Table.

The OECR3 register contains bits that enable or disable individual output clock channels [15:8]

Bit	Field	Туре	Reset	Description
7	Output Enable, CK15	R/W	1h	This bit controls the output enable signal for output channel CK15_P/CK15_N.
				0h = Output Disabled
				1h = Output Enabled
6	Output Enable, CK14	R/W	1h	This bit controls the output enable signal for output channel CK14_P/CK14_N.
				0h = Output Disabled
				1h = Output Enabled
5	Output Enable, CK13	R/W	1h	This bit controls the output enable signal for output channel CK13_P/CK13_N.
				0h = Output Disabled
				1h = Output Enabled
4	Output Enable, CK12	R/W	1h	This bit controls the output enable signal for output channel CK12_P/CK12_N.
				0h = Output Disabled
				1h = Output Enabled
3	Output Enable, CK11	R/W	1h	This bit controls the output enable signal for output channel CK11_P/CK11_N.
				0h = Output Disabled
				1h = Output Enabled
2	Output Enable, CK10	R/W	1h	This bit controls the output enable signal for output channel CK10_P/CK10_N.
				0h = Output Disabled
				1h = Output Enabled
1	Output Enable, CK9	R/W	1h	This bit controls the output enable signal for output channel CK9_P/CK9_N.
				0h = Output Disabled
				1h = Output Enabled
0	Output Enable, CK8	R/W	1h	This bit controls the output enable signal for output channel CK8_P/CK8_N.
				0h = Output Disabled
				1h = Output Enabled

#### Table 7. OECR3 Register Field Descriptions

#### 7.6.1.4 OERDBK Register (Address = 3h) [reset = 0h]

OERDBK is shown in Table 8.

Return to the Summary Table.

The OERDBK register contains bits that report the current state of the OE[12:5]# input pins.

Bit	Field	Туре	Reset	Description
7	OE12# State	R	0h	This bit reports the logic level present on the OE12# pin.
6	OE11# State	R	0h	This bit reports the logic level present on the OE11# pin.
5	OE10# State	R	0h	This bit reports the logic level present on the OE10# pin.
4	OE9# State	R	0h	This bit reports the logic level present on the OE9# pin.
3	OE8# State	R	0h	This bit reports the logic level present on the OE8# pin.

#### Table 8. OERDBK Register Field Descriptions



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#### Table 8. OERDBK Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
2	OE7# State	R	0h	This bit reports the logic level present on the OE7# pin.
1	OE6# State	R	0h	This bit reports the logic level present on the OE6# pin.
0	OE5# State	R	0h	This bit reports the logic level present on the OE5# pin.

#### 7.6.1.5 SBRDBK Register (Address = 4h) [reset = 1h]

SBRDBK is shown in Table 9.

Return to the Summary Table.

The SBRDBK register contains a bit that report the current state of the SBEN input pin.

#### **Table 9. SBRDBK Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7-1	RESERVED	R	0h	Reserved
0	SBEN State	R/W	1h	This bit reports the logic level present on the SBEN pin.

#### 7.6.1.6 VDRREVID Register (Address = 5h) [reset = X]

VDRREVID is shown in Table 10.

Return to the Summary Table.

The VDRREVID register contains a vendor identification code and silicon revision code.

Table 10	. VDRREVID	<b>Register Field</b>	Descriptions
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Bit	Field	Туре	Reset	Description
7-4	Revision Code[3:0]	R	x	Silicon revision code. Silicon revision code bits [3:0] map to register bits [7:4] directly.
3-0	Vendor ID[3:0]	R	X	Vendor identification code. Vendor ID bits [3:0] map to register bits [3:0] directly.

#### 7.6.1.7 DEVID Register (Address = 6h) [reset = X]

DEVID is shown in Table 11.

Return to the Summary Table.

The DEVID register contains a device identification code.

#### **Table 11. DEVID Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7-0	Device ID[7:0]	R	х	Device ID code.
				Device ID bits[7:0] map to register bits[7:0] directly.

#### 7.6.1.8 BTRDCNT Register (Address = 7h) [reset = 8h]

BTRDCNT is shown in Table 12.

Return to the Summary Table.

The BTRDCNT register allows configuration of the number of bytes that will be read back from the SMBus interface on an issued read command.

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Bit	Field	Туре	Reset	Description
7-6	RESERVED	R	0h	Reserved
5-0	Read Byte Count[5:0]	R/W	8h	Writing to this register configures how many bytes will be read back.

#### 7.6.1.9 SBIMSK1 Register (Address = 8h) [reset = 0h]

SBIMSK1 is shown in Table 13.

Return to the Summary Table.

The SBIMSK1 register allows the SMBus to force enable each output channel individually when the CDCDB2000 is in Side-Band interface mode.

7SBI Output Mask, CK7R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK7 Enabled6SBI Output Mask, CK6R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK6 Enabled5SBI Output Mask, CK5R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK6 Enabled4SBI Output Mask, CK4R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK5 Enabled4SBI Output Mask, CK4R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled3SBI Output Mask, CK3R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled2SBI Output Mask, CK2R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled2SBI Output Mask, CK1R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled1SBI Output Mask, CK1R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled1SBI Output Mask, CK0R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled1SBI Output Mask, CK0R/W0hThis bit overrides the the SBI output disable wh	Bit	Field	Туре	Reset	Description
0h = SBI Controls Output 1h = Output CK7 Enabled         6       SBI Output Mask, CK6       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK6 Enabled         5       SBI Output Mask, CK5       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK5 Enabled         4       SBI Output Mask, CK4       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK5 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit o	7	SBI Output Mask, CK7	R/W	0h	This bit overrides the the SBI output disable when set.
1       1					0h = SBI Controls Output
6       SBI Output Mask, CK6       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK6 Enabled         5       SBI Output Mask, CK5       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK5 Enabled         4       SBI Output Mask, CK4       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK5 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK4 Enabled         3       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output					1h = Output CK7 Enabled
Oh = SBI Controls Output 1h = Output CK6 Enabled5SBI Output Mask, CK5R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK5 Enabled4SBI Output Mask, CK4R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK5 Enabled3SBI Output Mask, CK3R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK4 Enabled3SBI Output Mask, CK3R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled2SBI Output Mask, CK2R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled1SBI Output Mask, CK1R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK2 Enabled0SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK2 Enabled1SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled0SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled0SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled	6	SBI Output Mask, CK6	R/W	0h	This bit overrides the the SBI output disable when set.
1h = Output CK6 Enabled         5       SBI Output Mask, CK5       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK5 Enabled         4       SBI Output Mask, CK4       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					0h = SBI Controls Output
5SBI Output Mask, CK5R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK5 Enabled4SBI Output Mask, CK4R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled3SBI Output Mask, CK3R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled3SBI Output Mask, CK3R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled2SBI Output Mask, CK2R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled1SBI Output Mask, CK1R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled0SBI Output Mask, CK0R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled0SBI Output Mask, CK0R/W0hThis bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					1h = Output CK6 Enabled
Oh = SBI Controls Output 1h = Output CK5 Enabled4SBI Output Mask, CK4R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK4 Enabled3SBI Output Mask, CK3R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK4 Enabled2SBI Output Mask, CK2R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled2SBI Output Mask, CK2R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK3 Enabled1SBI Output Mask, CK1R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK2 Enabled0SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled0SBI Output Mask, CK0R/WOhThis bit overrides the the SBI output disable when set. Oh = SBI Controls Output 1h = Output CK1 Enabled	5	SBI Output Mask, CK5	R/W	0h	This bit overrides the the SBI output disable when set.
4       SBI Output Mask, CK4       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					0h = SBI Controls Output
4       SBI Output Mask, CK4       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					1h = Output CK5 Enabled
0h = SBI Controls Output         1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       0h = SBI Controls Output       1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       0h       This bit overrides the the SBI output disable when set.       0h = SBI Controls Output         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set.         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set.         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       1h = Output CK1 Enabled       0h = SBI Controls Output       1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       1h = Output CK1 Enabled       0h = SBI Controls Output         1h = Output CK0 Enabled       1h = Output CK0 Enabled       0h = SBI Controls Output	4	SBI Output Mask, CK4	R/W	0h	This bit overrides the the SBI output disable when set.
1h = Output CK4 Enabled         3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					0h = SBI Controls Output
3       SBI Output Mask, CK3       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK3 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled					1h = Output CK4 Enabled
0h = SBI Controls Output         1h = Output CK3 Enabled         2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled	3	SBI Output Mask, CK3	R/W	0h	This bit overrides the the SBI output disable when set.
1       1					0h = SBI Controls Output
2       SBI Output Mask, CK2       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK2 Enabled         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         1       BI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output         1h = Output CK0 Enabled       1h = Output CK0 Enabled       1h = Output CK0 Enabled					1h = Output CK3 Enabled
Image: Sel Control Solution       0h = SBI Controls Output         1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled	2	SBI Output Mask, CK2	R/W	0h	This bit overrides the the SBI output disable when set.
Image: Sel Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK1 Enabled         0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK0 Enabled					0h = SBI Controls Output
1       SBI Output Mask, CK1       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       0h = SBI Controls Output         0       SBI Output Mask, CK0       R/W       0h         0h = SBI Controls Output       This bit overrides the the SBI output disable when set.         0h = SBI Output Mask, CK0       R/W       0h         1       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output         1h = Output CK0 Enabled					1h = Output CK2 Enabled
0       SBI Output Mask, CK0       R/W       0h       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       0h = SBI Controls Output       This bit overrides the the SBI output disable when set.         0h = SBI Controls Output       0h = SBI Controls Output         1h = Output CK0 Enabled	1	SBI Output Mask, CK1	R/W	0h	This bit overrides the the SBI output disable when set.
0     SBI Output Mask, CK0     R/W     0h     This bit overrides the the SBI output disable when set. 0h = SBI Controls Output       1h = Output CK1 Enabled     0h     This bit overrides the the SBI output disable when set. 0h = SBI Controls Output       1h = Output CK0 Enabled     1h = Output CK0 Enabled					0h = SBI Controls Output
0 SBI Output Mask, CK0 R/W 0h This bit overrides the the SBI output disable when set. 0h = SBI Controls Output 1h = Output CK0 Enabled					1h = Output CK1 Enabled
0h = SBI Controls Output 1h = Output CK0 Enabled	0	SBI Output Mask, CK0	R/W	0h	This bit overrides the the SBI output disable when set.
1h = Output CK0 Enabled					0h = SBI Controls Output
					1h = Output CK0 Enabled

#### Table 13. SBIMSK1 Register Field Descriptions

#### 7.6.1.10 SBIMSK2 Register (Address = 9h) [reset = 0h]

SBIMSK2 is shown in Table 14.

Return to the Summary Table.

The SBIMSK2 register allows the SMBus to force enable each output channel individually when the CDCDB2000 is in Side-Band interface mode.

Bit	Field	Туре	Reset	Description							
7	SBI Output Mask, CK15	R/W	0h	This bit overrides the the SBI output disable when set.							
				0h = SBI Controls Output							
				1h = Output CK15 Enabled							

#### Table 14. SBIMSK2 Register Field Descriptions



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Bit	Field	Туре	Reset	Description				
6	SBI Output Mask, CK14	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK14 Enabled				
5	SBI Output Mask, CK13	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK13 Enabled				
4	SBI Output Mask, CK12	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK12 Enabled				
3	SBI Output Mask, CK11	ut Mask, CK11 R/W 0h		This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK11 Enabled				
2	SBI Output Mask, CK10	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK10 Enabled				
1	SBI Output Mask, CK9	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK9 Enabled				
0	SBI Output Mask, CK8	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK8 Enabled				

#### Table 14. SBIMSK2 Register Field Descriptions (continued)

### 7.6.1.11 SBIMSK3 Register (Address = Ah) [reset = 0h]

SBIMSK3 is shown in Table 15.

Return to the Summary Table.

The SBIMSK3 register allows the SMBus to force enable each output channel individually when the CDCDB2000 is in Side-Band interface mode.

Bit	Field	Туре	Reset	Description				
7-4	RESERVED	R	0h	Reserved				
3	SBI Output Mask, CK19	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK19 Enabled				
2	SBI Output Mask, CK18	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK18 Enabled				
1	SBI Output Mask, CK17	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK17 Enabled				
0	SBI Output Mask, CK16	R/W	0h	This bit overrides the the SBI output disable when set.				
				0h = SBI Controls Output				
				1h = Output CK16 Enabled				

Table 15. SBIMSK3 Register Field Descriptions



### 8 Application and Implementation

注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 8.1 Application Information

The CDCDB2000 is a fanout buffer that supports PCIe generation 4 and PCIe generation 5 REFCLK distribution. It is used to create, and distribute, up to 20 copies of a typically 100-MHz clock.

#### 8.2 Typical Application

In shows a CDCDB2000 typical application. In this application, a clock generator provides a 100-MHz reference to the CDCDB2000 which then distributes that clock to PCIe endpoints. The clock generator may be a discrete clock generator like the LMK03328 or it may be integrated in a larger component such as a PCH or application processor.



图 10. Typical Application

#### 8.2.1 Design Requirements

Consider a typical server motherboard application which needs to distribute a 100-MHz PCIe reference clock from the PCH of a processor chipset to multiple endpoints. An example of clock input and output requirements is:

- Clock Input:
  - 100-MHz LP-HCSL
- Clock Output:
  - 2x 100-MHz to processors, LP-HCSL
  - 2x 100-MHz to riser/retimer, LP-HCSL
  - 2x 100-MHz to DDR memory controller, LP-HCSL

The section below describes the design procedure to configure the CDCDB2000 to output the frequencies for the above scenario.

#### 8.2.2 Detailed Design Procedure

The following items must be determined before starting design of a CDCDB2000 socket:

- Output Enable Control Method
- SMBus address



#### Typical Application (接下页)

#### 8.2.2.1 Output Enable Control Method

If the SMBus and OE# pins should be used for controlling output states, the SBEN pin should be tied to a low potential. This could be selected for hot swapping where pin control by a CPLD or other hot swap controller is needed to enable/disable the reference clock to safeguard against backdriving a connected device.

#### 8.2.2.2 SMBus Address

An SMBus address should be selected from the listed potential addresses in 表 1. The appropriate pullup or pulldown resistor should be placed on the SADRx pins as indicated in the table. Ensure the SMBus address is not already in use to avoid conflict.

#### 8.2.3 Application Curve

The graph listed in 表 16 is used as both an application curve and a typical characteristics plot (see the *Typical Characteristics* section).

#### 表 16. Table of Graphs

TITLE	FIGURE			
CDCDB2000 Clock Out (CK0:19) Phase Noise	图 5			



### 9 Power Supply Recommendations

High-performance clock buffers are sensitive to noise on the power supply, which can dramatically increase the additive jitter of the buffer. Thus, it is essential to reduce noise from the system power supply, especially when the jitter and phase noise is critical to applications.

Filter capacitors are used to eliminate the low-frequency noise from the power supply, where the bypass capacitors provide the very low impedance path for high-frequency noise and guards the power supply system against induced fluctuations. These bypass capacitors also provide instantaneous current surges as required by the device and should have low equivalent series resistance (ESR). To properly use the bypass capacitors, they must be placed very close to the power-supply terminals and laid out with short loops to minimize inductance. TI recommends to insert a ferrite bead between the board power supply and the chip power supply that isolates the high-frequency switching noises generated by the clock buffer. These beads prevent the switching noise from leaking into the board supply. It is imperative to choose an appropriate ferrite bead with very low DC resistance to provide adequate isolation between the board supply and the chip supply, as well as to maintain a voltage at the supply terminals that is greater than the minimum voltage required for proper operation.

shows the recommended power supply filtering and decoupling method.



图 11. Power Supply Decoupling



#### 10 Layout

#### 10.1 Layout Guidelines

The following section provides the layout guidelines to ensure good thermal performance and power supply connections for the CDCDB2000.

#### **10.2 Layout Examples**

The CDCDB2000 has 85- $\Omega$  differential output impedance LP-HCSL format drivers. All transmission lines connected to CKx pins should be 85- $\Omega$  differential impedance, 42.5- $\Omega$  single-ended impedance to avoid reflections and increased radiated emissions. Take care to eliminate or reduce stubs on the transmission lines.



图 12. PCB Layout Example for CDCDB2000, Top Layer



# Layout Examples (接下页)



图 13. PCB Layout Example for CDCDB2000, GND Layer



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# Layout Examples (接下页)



# 图 14. PCB Layout Example for CDCDB2000, Bottom Layer

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### 11 器件和文档支持

#### 11.1 器件支持

#### 11.1.1 TICS Pro

TICS Pro 是用于 EVM 编程的离线软件工具,也可以用生成寄存器映射,为特定应用的器件配置编程。如需 TICS Pro,请访问 http://www.ti.com.cn/tool/cn/TICSPRO-SW。

#### 11.2 接收文档更新通知

要接收文档更新通知,请导航至 ti.com.cn 上的器件产品文件夹。单击右上角的通知我进行注册,即可每周接收产品信息更改摘要。有关更改的详细信息,请查看任何已修订文档中包含的修订历史记录。

#### 11.3 支持资源

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 11.4 商标

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

#### 11.5 静电放电警告

ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序,可能会损坏集成电路。



ESD 的损坏小至导致微小的性能降级,大至整个器件故障。精密的集成电路可能更容易受到损坏,这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

#### 11.6 Glossary

#### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

#### 12 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更,恕不另行通知,且 不会对此文档进行修订。如需获取此数据表的浏览器版本,请查阅左侧的导航栏。

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Ⅱ 均以"原样"提供技术性及可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源,不保证其中不含任何瑕疵,且不做任何明示或暗示的担保,包括但不限于对适销性、适合某特定用途或不侵犯任何第三方知识产权的暗示担保。

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10-Dec-2020

# PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CDCDB2000NPPR	ACTIVE	TLGA	NPP	80	3000	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	CDCDB 2000	Samples
CDCDB2000NPPT	ACTIVE	TLGA	NPP	80	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	CDCDB 2000	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE OPTION ADDENDUM

10-Dec-2020

# PACKAGE MATERIALS INFORMATION

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Texas Instruments

## TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CDCDB2000NPPR	TLGA	NPP	80	3000	330.0	16.4	6.3	6.3	1.1	12.0	16.0	Q2
CDCDB2000NPPT	TLGA	NPP	80	250	180.0	16.4	6.3	6.3	1.1	12.0	16.0	Q2

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

19-Feb-2020



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CDCDB2000NPPR	TLGA	NPP	80	3000	367.0	367.0	38.0
CDCDB2000NPPT	TLGA	NPP	80	250	210.0	185.0	35.0

# **NPP0080A**



# **PACKAGE OUTLINE**

# TLGA - 0.9 mm max height

THIN LAND GRID ARRAY



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.

3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



# **NPP0080A**

# **EXAMPLE BOARD LAYOUT**

# TLGA - 0.9 mm max height

THIN LAND GRID ARRAY



NOTES: (continued)

- 4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints.
- See Texas Instruments Literature No. SNVA009 (www.ti.com/lit/snva009).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



# **NPP0080A**

# **EXAMPLE STENCIL DESIGN**

# TLGA - 0.9 mm max height

THIN LAND GRID ARRAY



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



#### 重要声明和免责声明

Ⅱ 均以"原样"提供技术性及可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源,不保证其中不含任何瑕疵,且不做任何明示或暗示的担保,包括但不限于对适销性、适合某特定用途或不侵犯任何第三方知识产权的暗示担保。

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